PRODUCT CHANGE NOTICE

PART NUMBER(S):
Please see attachment.

PCN No.: 06-0130-10a

DATE: March 7, 2006

PART DESCRIPTION:
Power Management and Interface Products – Change in Wafer Fabrication Site

LEVEL OF CHANGE:

[X] Level I, Customer Approval.  [ ] Level II, Customer Information.

PRODUCT ATTRIBUTE AFFECTED:

[ ] Material Change  [ ] Data Sheet Change
[ ] Design Change  [ ] Package Change
[X] Process Change  [ ] Packing / Shipping

[X] Other, Explain: Wafer Fabrication Site Transfer

DESCRIPTION OF CHANGE:
Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry Silan. See attached Product List no. 10.

REASON FOR CHANGE:
Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.

FABRICATION PROCESS QUALIFICATION COMPLETED (DATE): 5/28/06
PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE): 7/9/06

* Samples representative of product from the Product Family being transferred.
PRODUCT CHANGE NOTICE

EARLIEST DATE OF PRODUCTION
SHIPMENTS: 10/23/06

EFFECTIVITY CHANGE DATE OR DATE CODE: Work week associated with earliest production shipment.

[ ] STANDARD DISTRIBUTION [ X ] CUSTOM DISTRIBUTION

PERSON TO CONTACT WITH QUESTIONS:

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PCN No.: 06-0130-10a

List 10

SP3508CF
SP3508CF-L
SP3508EF
SP3508EF-L